

WHAT IS CLAIMED IS:

1. An information processing device comprising:

a housing comprising a metal heat conductor and a plurality of passages;

a processor disposed in said housing in thermal communication with said

5 heat conductor, wherein said processor generates heat when energized, and wherein
said heat conductor dissipates heat generated by said processor to an area external
of said housing through said passages;

a circuit board arranged in said housing and comprising a mounting area,
wherein said processor is mounted at said mounting area;

10 a pusher pushing said processor in a direction toward said heat conductor;
and

wherein said pusher is disposed between said processor and said housing.

2. The information processing device of claim 1 wherein said circuit board is a
printed circuit board.

15 3. The information processing device of claim 1 wherein said device is used for
printing.